

Cookson Group Plaskon® S-7P Epoxy Encapsulant (discontinued **)

Category : Polymer , Thermoset , Epoxy , Epoxy Encapsulant, Unreinforced

Material Notes:

Test specimens were transfer molded and post cured 4 hours at 175°C. A low stress, low viscosity epoxy encapsulant designed for packaging stress-sensitive semiconductor devices. It is specifically formulated to provide a lower viscosity for those low stress applications where wire sweep may be a concern. Excellent low stress properties; Consistent moldability (low viscosity, easy of mold filling, fast cycles and good hot hardness); Outstanding cosmetics and markability; Superior reliability

Order this product through the following link:

http://www.lookpolymers.com/polymer_Cookson-Group-Plaskon-S-7P-Epoxy-Encapsulant-nbspdiscontinued-.php

Physical Properties	Metric	English	Comments
Density	1.82 g/cc	0.0658 lb/in ³	
Viscosity	8500 cP @Temperature 175 °C	8500 cP @Temperature 347 °F	Automatic orifice Viscosity
Linear Mold Shrinkage	0.0037 cm/cm	0.0037 in/in	
Spiral Flow	100 - 130 cm	39.4 - 51.2 in	177°C/1000 psi

Mechanical Properties	Metric	English	Comments
Hardness, Shore D	73	73	
Tensile Strength, Ultimate	62.0 MPa	8990 psi	
Flexural Strength	103 MPa	14900 psi	
Flexural Modulus	13.0 GPa	1890 ksi	

Thermal Properties	Metric	English	Comments
CTE, linear	18.0 µm/m-°C @Temperature 20.0 °C	10.0 µin/in-°F @Temperature 68.0 °F	
CTE, linear, Transverse to Flow	45.0 µm/m-°C @Temperature 20.0 °C	25.0 µin/in-°F @Temperature 68.0 °F	
Thermal Conductivity	0.700 W/m-K	4.86 BTU-in/hr-ft ² -°F	
Glass Transition Temp, Tg	150 °C	302 °F	
Flammability, UL94	V-0 @Thickness 1.60 mm	V-0 @Thickness 0.0630 in	
	V-0	V-0	

Thermal Properties	Metric @ Thickness 1.60 mm	English @ Thickness 0.0630 in	Comments
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Electrical Properties	Metric	English	Comments
Dielectric Constant	3.8 @Frequency 1000 Hz	3.8 @Frequency 1000 Hz	
Dielectric Strength	16.0 kV/mm	406 kV/in	
Dissipation Factor	0.0020 @Frequency 1000 Hz	0.0020 @Frequency 1000 Hz	
Arc Resistance	180 sec	180 sec	

Processing Properties	Metric	English	Comments
Processing Temperature	170 - 185 °C	338 - 365 °F	Molding temperature

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